

**INTER PARTES REVIEW-PETITIONER
POWER OF ATTORNEY OR
REVOCATION OF POWER OF ATTORNEY WITH
A NEW POWER OF ATTORNEY
AND
CHANGE OF CORRESPONDENCE ADDRESS**

Proceeding	To be assigned
Filing Date(s)	Herewith
First Named Inventor	Tong
Title	METHOD OF EPITAXIAL-LIKE WAFER BONDING AT LOW TEMPERATURE AND BONDED STRUCTURE
Patent Number	6,563,133
Attorney Docket No.	TSM6563133RV

I hereby revoke all previous requester powers of attorney given in the above-identified inter partes review proceeding

☐ A Power of Attorney is submitted herewith.

OR

☒ I hereby appoint Practitioner(s) associated with the following Customer Number as my/our attorney(s) or agent(s) to prosecute the proceeding(s) identified above, and to transact all business in the United States Patent and Trademark Office connected therewith:

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OR

☐ I hereby appoint Practitioner(s) named below as my/our attorney(s) or agent(s) to prosecute the proceeding(s) identified above, and to transact all business in the United States Patent and Trademark Office connected therewith:

Practitioner(s) Name	Registration Number

Please recognize or change the correspondence address for the above-identified reexamination proceeding control number(s) (more than one may be changed **only** if they are merged proceedings) to be:

☒ The address associated with the above-mentioned Customer Number.

OR

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OR

<input type="checkbox"/> Firm or Individual Name				
Address				
City		State		Zip
Country				
Telephone		Email		

SIGNATURE of Petitioner

Signature	<i>Donald R. McKenna</i>	Date	11/11/2013
Name	Donald R. McKenna	Telephone	1-886-3-563-6688
Title and Company	Deputy Director, Taiwan Semiconductor Manufacturing Co., Ltd		